

TC1321

10-Bit Digital-to-Analog Converter with Two-Wire Interface

Features

- 10-Bit Digital-to-Analog Converter
- 2.7-5.5V Single Supply Operation
- Simple SMBus/I²C[™] Serial Interface
- Low Power: 350μA Operation, 0.5μA Shutdown
- 8-Pin SOIC and 8-Pin MSOP Packages

Applications

- Programmable Voltage Sources
- Digital Controlled Amplifiers/Attenuators
- Process Monitoring and Control

Device Selection Table

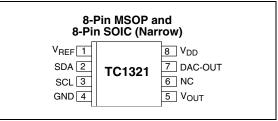
Part Number	Package	Temperature Range			
TC1321EOA	8-Pin SOIC (Narrow)	-40°C to +85°C			
TC1321EUA	8-Pin MSOP	-40°C to +85°C			

General Description

The TC1321 is a serially accessible 10-bit voltage output digital-to-analog converter (DAC). The DAC produces an output voltage that ranges from ground to an externally supplied reference voltage. It operates from a single power supply that can range from 2.7V to 5.5V, making it ideal for a wide range of applications. Built into the part is a Power-on Reset function that ensures that the device starts at a known condition.

Communication with the TC1321 is accomplished via a simple 2-wire SMBus/I²C compatible serial port, with the TC1321 acting as a slave only device. The host can enable the SHDN bit in the CONFIG register to activate the Low Power Standby mode.

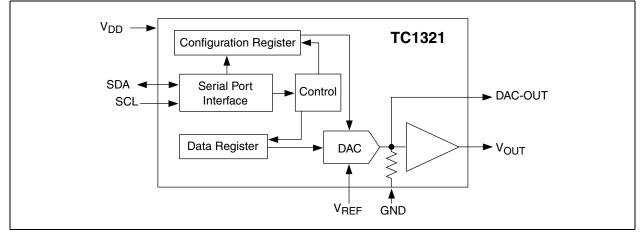
Package Type



VIN (8) VDD TC1321 VOUT VOUT VOUT VOUT VOUT VADJUST Serial Port (3) (2) SCLK SDAT Microcontroller

Typical Application

Functional Block Diagram



1.0 **ELECTRICAL CHARACTERISTICS**

Absolute Maximum Ratings*

Supply Voltage (V _{DD})+6V	
Voltage on any Pin (GND – 0.3V) to $(V_{DD} + 0.3V)$	
Current on any Pin ±50mA	
Package Thermal Resistance (θ_{JA})	
Operating Temperature (T _A) See Below	
Storage Temperature (T _{STG})65°C to +150°C	

*Stresses above those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only and functional operation of the device at these or any other conditions above those indicated in the operation sections of the specifications is not implied. Exposure to Absolute Maximum Rating conditions for extended periods may affect device reliability.

TC1321 ELECTRICAL SPECIFICATIONS

Electrical Ch	paracteristics: V_{DD} = 2.7V to 5.5V, -40°C ≤	≤ T _A ≤ +85	°C, V _{REF} =	1.2 unless ot	herwise r	noted.
Symbol	Parameter		Тур	Max	Unit	Test Conditions
Power Supp	ly					
V _{DD}	Supply Voltage	2.7	_	5.5	V	
I _{DD}	Operating Current		350	500	mA	V _{DD} = 5.5V, V _{REF} = 1.2V Serial Port Inactive (Note 1)
I _{DD-STANDBY}	Standby Supply Current		0.1	1	μΑ	V _{DD} = 3.3V Serial Port Inactive (Note 1)
Static Perfor	mance - Analog Section					
	Resolution			10	Bits	
INL	Integral Non-Linearity at FS, $T_A = +25^{\circ}C$		_	±4.0	LSB	(Note 2)
FSE	Full Scale Error	_	—	±3	%FS	
DNL	Differential Non-Linearity, $T_A = +25^{\circ}C$	-1	—	+2	LSB	All Codes (Note 2)
V _{OS}	Offset Error at V _{OUT}	_	±0.3	±8	mV	(Note 2)
TCV _{OS}	Offset Error Tempco at V _{OUT}	_	10	_	μv/°C	
PSRR	Power Supply Rejection Ratio	_	80	_	dB	V _{DD} at DC
V _{REF}	Voltage Reference Range	0	—	V _{DD} – 1.2	V	
I _{REF}	Reference Input Leakage Current		_	±1.0	μA	
V _{SW}	Voltage Swing	0	_	V _{REF}	V	$V_{REF} \le (V_{DD} - 1.2V)$
R _{OUT}	Output Resistance @ V _{OUT}		5.0	_	Ω	R _{OUT} (Ω)
I _{OUT}	Output Current (Source or Sink)		2	_	mA	
I _{SC}	Output Short-Circuit Current $V_{DD} = 5.5V$		30 20	50 50	mA mA	Source Sink
Dynamic Pe	formance					
SR	Voltage Output Slew Rate	_	0.8	—	V/µs	
t _{SETTLE}	Output Voltage Full Scale Settling Time		10	_	μsec	
t _{WU}	Wake-up Time		20	_	μs	
	Digital Feed Through and Crosstalk		5	_	nV-s	SDA = V _{DD} , SCL = 100kHz
Serial Port I	nterface					
V _{IH}	Logic Input High	2.4	_	V _{DD}	V	
V _{IL}	Logic Input Low	_	_	0.6		
V _{OL}	SDA Output Low	_		0.4 0.6	V V	$I_{OL} = 3mA$ (Sinking Current) $I_{OL} = 6mA$
C _{IN}	Input Capacitance SDA, SCL		5	0.4	pF	
I _{LEAK}	I/O Leakage	_	_	±1.0	μA	

Note1:SDA and SCL must be connected to V_{DD} or GND.2:Measured at $V_{OUT} \ge 50 mV$ referred to GND to avoid output buffer clipping.

TC1321 ELECTRICAL SPECIFICATIONS (CONTINUED)

Electrical Characteristics: $V_{DD} = 2.7V$ to 5.5V, -40°C $\leq T_A \leq +85$ °C, $V_{REF} = 1.2$ unless otherwise noted.											
Symbol	Parameter	Min	Тур	Max	Unit	Test Conditions					
Serial Port A	AC Timing				•	·					
f _{SMB}	SMBus Clock Frequency	10	_	100	kHz						
t _{IDLE}	Bus Free Time Prior to New Transition		_	_	μsec						
t _{H(START)}	START Condition Hold Time	4.0	—	_	μsec						
t _{SU(START)}	START Condition Setup Time	4.7	_	_	µsec	90% SCL to 10% SDA (for Repeated START Condition)					
t _{SU(STOP)}	STOP Condition Setup Time	4.0	_	_	μsec						
t _{H-DATA}	Data In Hold Time	100	—	_	nsec						
t _{SU-DATA}	Data In Setup Time	100	_	_	nsec						
t _{LOW}	Low Clock Period	4.7	_	_	μsec	10% to 10%					
t _{HIGH}	High Clock Period	4	_	_	μsec	90% to 90%					
t _F	SMBus Fall Time	_	_	300	nsec	90% to 10%					
t _R	SMBus Rise Time	_		1000	nsec	10% to 90%					
t _{POR}	Power-on Reset Delay		500	_	μsec	$V_{DD} \ge V_{POR}$ (Rising Edge					

Note 1: SDA and SCL must be connected to V_{DD} or GND.
2: Measured at V_{OUT} ≥ 50mV referred to GND to avoid output buffer clipping.

2.0 PIN DESCRIPTIONS

The descriptions of the pins are listed in Table 2-1.

Pin Number	Symbol	Туре	Description
1	V _{REF}	Input	Input. Voltage Reference Input can range from 0V to 1.2V below V _{DD} .
2	SDA	Bi-Directional	Bi-directional. Serial data is transferred on the SMBus in both directions using this pin.
3	SCL	Input	Input. SMBus serial clock. Clocks data into and out of the TC1321.
4	GND	Power	Ground.
5	V _{OUT}	Output	Output. Buffered DAC output voltage. This voltage is a function of the reference voltage and the contents of the DATA register.
6	NC	None	No connection.
7	DAC-OUT	Output	Output. Unbuffered DAC output voltage. This voltage is a function of the reference voltage and the contents of the DATA register. This output is unbuffered and care must be taken that the pin is connected only to a high-impedance node.
8	V _{DD}	Power	Positive power supply input. See electrical specifications.

3.0 DETAILED DESCRIPTION

The TC1321 is a monolithic 10-bit digital-to-analog converter that is designed to operate from a single supply that can range from 2.7V to 5.5V. The DAC consists of a data register (DATA), a configuration register (CONF), and a current output amplifier. The TC1321 uses an external reference which also determines the maximum output voltage.

The TC1321 uses a current steering DAC based on an array of matched current sources. This current, along with a precision resistor, converts the contents of the Data Register and V_{REF} into an output voltage, V_{OUT} given by:

 $V_{OUT} = V_{REF} (DATA/1024)$

3.1 Reference Input

The reference pin, V_{REF} is a buffered high-impedance input and because of this, the load regulation of the reference source needs only to be able to tolerate leakage levels of current (less than 1µA). V_{REF} accepts a voltage range from 0 to (V_{DD} – 1.2V). Input capacitance is typically 10pF.

3.2 Output Amplifier

The TC1321 DAC output is buffered with an internal unity gain rail-to-rail input/output amplifier with a typical slew rate of $0.8V/\mu$ sec. Maximum full scale transition settling time is 10 μ sec to within ±1/2LSB when loaded with 1k Ω in parallel with 100pF.

3.3 Standby Mode

The TC1321 allows the host to put it into a Low Power ($I_{DD} = 0.5\mu A$, typical) Standby mode. In this mode, the D/A conversion is halted. The SMBus port operates normally. Standby mode is enabled by setting the SHDN bit in the CONFIG register. The table below summarizes this operation.

TABLE 3-1: STANDBY MODE OPERATION

SHDN Bit	Operating Mode					
0	Normal					
1	Standby					

3.4 SMBus Slave Address

The TC1321 is internally programmed to have a default SMBus address value of 1001 000b. Seven other addresses are available by custom order (contact factory). See Figure 3-1 for location of address bits in SMBus protocol.

FIGURE 3-1: SMBus PROTOCOLS

	S /	Addres	s	R/W	ACK	Cor	nmand	ACK	Da	ita 🛛 🖌	ACK	Р			
		7-Bits		0			B-Bits			Bits		•	-		
	1	Addre	ss	I	I	-	nand Byte:	selects		Byte: d	lata doe	es			
Vri	ite 2-Byte						register yo		into	the register the comm	ster set				
	S	Addres	ss	R/W	ACK	Co	ommand	ACK	(C	ata	ACK	Da	ta	ACK	F
		7-Bi	s	0			8-Bits		8	-Bits		8-E	Bits		
e	Sla ad 1-Byte l	ve Add				whic	imand Byte h register y ng to.		into	ta Byte: the reg the com	gister se	ət			
	Address	R/W		Common		< S	Address	R/W	ACK	Data	NACK		7		
3	7-Bits	R/W	ACK	Comman 8-Bits	d ACł	\ 3	7-Bits	H/W	ACK	8-Bits	NACK	K P	-		
	ad 2-Byte	Forma R/W		eading fro		< S	flow direct	on.	ACK	comma Data	and byte	_	ata	NACK	
.															I P
	7-Bits	0		8-Bits			7-Bits	1		8-Bits		8-6	Bits	NAON	
		0 ess	Co wh rea		yte: sele er you ar	cts e		1 ess: rep nge in da	eated		yte: rea ister se	8-E ds fro t by tl	Bits om		
	7-Bits Slave Addr	0 ess te Fori	Co wh rea	8-Bits mmand B ich registe ading from	yte: sele er you ar	cts e	7-Bits Slave Addr due to char	1 ess: rep nge in da	eated	8-Bits Data By the reg	yte: rea ister se	8-E ds fro t by tl	Bits om		
ec	7-Bits Slave Addr	0 ess te Fori	Co wh rea	8-Bits mmand B ich registe ading from	yte: sele er you ar	cts e	7-Bits Slave Addr due to char	1 ess: rep nge in da	eated	8-Bits Data By the reg	yte: rea ister se	8-E ds fro t by tl	Bits om		H
lec S = ha	7-Bits Slave Addr ceive 1-By Address	0 ess te Forn s R/W 1 ndition dition dition	Co wh rea mat 7 ACk	8-Bits mmand B ich registe ading from	yte: sele er you ar NACK yte: read	P s data	7-Bits Slave Addr due to char flow direction flow direction flow direction flow direction	1 ess: rep nge in da	eated	8-Bits Data By the reg	yte: rea ister se	8-E ds fro t by tl	Bits om		F
ec S = ha	7-Bits Slave Addr ceive 1-By Address START Con STOP Con aded = Slave ceive 1-By	0 ess te Forn s R/V 1 ndition dition e Trans te Forn	Co wh rea 7 ACk mission	8-Bits mmand B ich registe ading from 0 Data 8-Bits Data By the regin the last byte tra	yte: sele er you ar NACK yte: read ister com read by	P s data	7-Bits Slave Addr due to char flow direction flow direction a from ded by vrite	1 ess: rep nge in da	eated	8-Bits Data By the reg	yte: rea ister se	8-E ds fro t by tl	Bits om		F
lec S = ha	7-Bits Slave Addr ceive 1-By Address START Con STOP Con aded = Slave ceive 1-By	0 ess te Forn s R/W 1 ndition dition e Trans te Forn	Co wh rea 7 ACk mission	8-Bits mmand B ich registe ading from Data 8-Bits Data By the regin the last byte tra	yte: sele er you ar NACK yte: read ister com read by nsmission	P s data mano te or v on.	7-Bits Slave Addr due to char flow direction flow direction a from ded by vrite	1 ess: rep nge in da on.	eated	8-Bits Data By the reg	yte: rea ister se	8-E ds fro t by tl	Bits om		P

4.0 SERIAL PORT OPERATION

The Serial Clock input (SCL) and bi-directional data port (SDA) form a 2-wire bi-directional serial port for programming and interrogating the TC1321. The following conventions are used in this bus architecture.

TABLE 4-1: TC1321 SERIAL BUS CONVENTIONS

Term	Explanation
Transmitter	The device sending data to the bus.
Receiver	The device receiving data from the bus.
Master	The device which controls the bus: initiating transfers (START), generating the clock, and terminating transfers (STOP).
Slave	The device addressed by the master.
START	A unique condition signaling the beginning of a transfer indicated by SDA falling (High - Low) while SCL is high.
STOP	A unique condition signaling the end of a transfer indicated by SDA rising (Low - High) while SCL is high.
ACK	A Receiver Acknowledges the receipt of each byte with this unique condition. The Receiver drives SDA low during SCL high of the ACK clock pulse. The Master provides the clock pulse for the ACK cycle.
Busy	Communication is not possible because the bus is in use.
Not Busy	When the bus is IDLE, both SDA and SCL will remain high.
Data Valid	The state of SDA must remain stable during the High period of SCL in order for a data bit to be considered valid. SDA only changes state while SCL is low during normal data transfers. (See START and STOP conditions.)

All transfers take place under control of a host, usually a CPU or microcontroller, acting as the Master, which provides the clock signal for all transfers. The TC1321 *always* operates as a Slave. The serial protocol is illustrated in Figure 3-1. All data transfers have two phases; all bytes are transferred MSB first. Accesses are initiated by a START condition (START), followed by a device address byte and one or more data bytes. The device address byte includes a Read/Write selection bit. Each access must be terminated by a STOP Condition (STOP). A convention called *Acknowledge* (ACK) confirms receipt of each byte. Note that SDA can change only during periods when SCL is LOW (SDA changes while SCL is HIGH are reserved for START and STOP conditions).

4.1 START Condition (START)

The TC1321 continuously monitors the SDA and SCL lines for a START condition (a HIGH to LOW transition of SDA while SCL is HIGH), and will not respond until this condition is met.

4.2 Address Byte

Immediately following the START condition, the host must transmit the address byte to the TC1321. The 7-bit SMBus address for the TC1321 is 1001000. The 7-bit address transmitted in the serial bit stream must match for the TC1321 to respond with an Acknowledge (indicating the TC1321 is on the bus and ready to accept data). The eighth bit in the Address Byte is a Read-Write bit. This bit is a 1 for a read operation or 0 for a write operation. During the first phase of any transfer, this bit will be set = 0 to indicate that the command byte is being written.

4.3 Acknowledge (ACK)

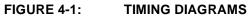
Acknowledge (ACK) provides a positive handshake between the host and the TC1321. The host releases SDA after transmitting eight bits, then generates a ninth clock cycle to allow the TC1321 to pull the SDA line LOW to Acknowledge that it successfully received the previous eight bits of data or address.

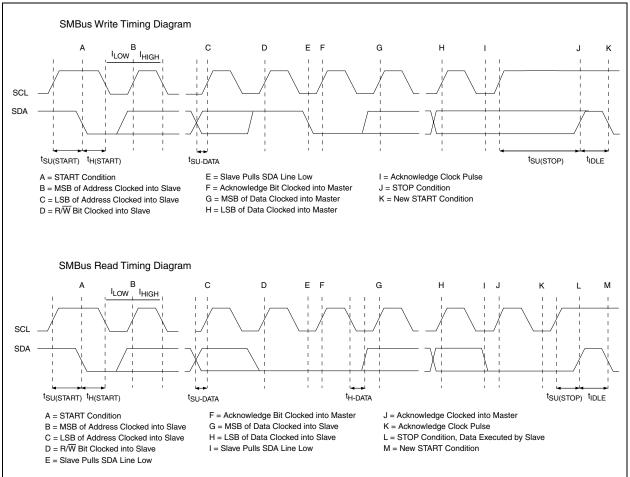
4.4 Data Byte

After a successful ACK of the address byte, the host must transmit the data byte to be written or clock out the data to be read. (See the appropriate timing diagrams.) ACK will be generated after a successful write of a data byte into the TC1321.

4.5 Stop Condition (STOP)

Communications must be terminated by a STOP condition (a LOW to HIGH transition of SDA while SCL is HIGH). The STOP condition must be communicated by the transmitter to the TC1321. Refer to Figure 4-1, Timing Diagrams for serial bus timing.





4.6 Register Set and Programmer's Model

TABLE 4-2: TC1321 COMMAND SET (SMBus READ_BYTE AND WRITE_BYTE)

Command Byte Description								
Command	Code	Function						
RWD	00h	Read/Write Data (DATA)						
RWCR	01h	Read/Write Configuration (CONFIG)						

TABLE 4-3:CONFIGURATION REGISTER
(CONFIG), 8-BIT, READ/WRITE

	Configuration Register (CONFIG)										
D[7]	D[6]	D[5]	D[4]	D[3]	D[2]	D[1]	D[0]				
	Reserved SHDN										
В	it	POR	Fund	ction	Туре	Оре	ration				
D	D[0] 0		Standby	Switch	Read/ Write		tandby Iormal				
D[7]-D[1] 0		Reserve Always r Zero whe	eturns	N/A	N	I/A					

TABLE 4-4:DATA REGISTER (DATA),
10-BIT, READ/WRITE

Data Register (DATA) for 1st Byte										
D[9]	D[8]	D[7]	D[6]	D[5]	D[4]	D[3]	D[2]			
MSB	Х	Х	Х	Х	Х	Х	Х			
	Data Register (DATA) for 2nd Byte									
D[1]	D[0]	Х	Х	Х	Х	Х	Х			
Х	LSB	Х	Х	Х	Х	Х	Х			

The DAC output voltage is a function of reference voltage and the binary value of the contents of the register DATA. The transfer function is given by the expression:

EQUATION 4-1:

$V_{OUT} = V_{REF} x$	<u>DATA</u>
OUT REF	1024 🛛

4.7 Register Set Summary

The TC1321's register set is summarized in Table 4-5 below. All registers are 10-bits wide.

TABLE 4-5:	TC1321 REGISTER SET
	SUMMARY

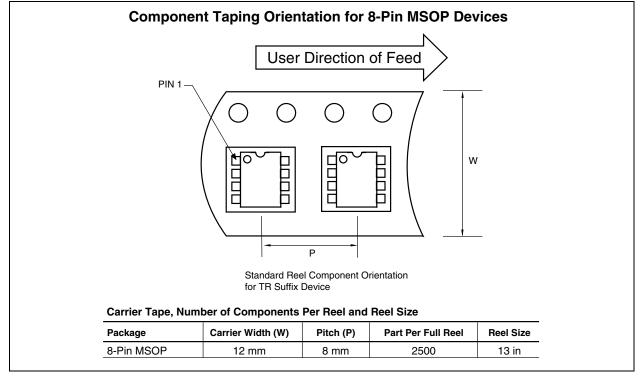
Name	Description	POR State	Read	Write
Data	DATA Register (2-Byte Format)	d000000000b	Х	Х
Config	CONFIG Register	0000 0000b	Х	Х

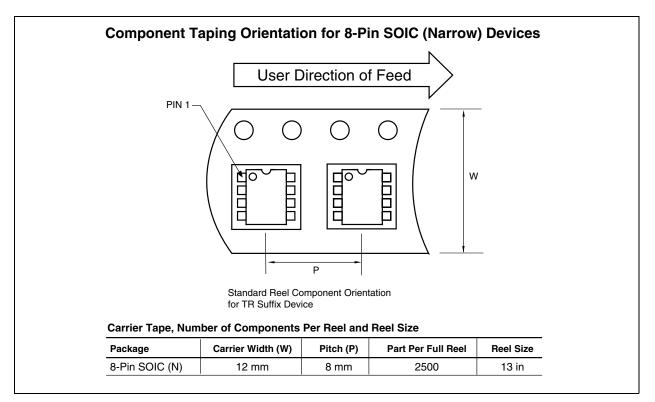
5.0 PACKAGING INFORMATION

5.1 Package Marking Information

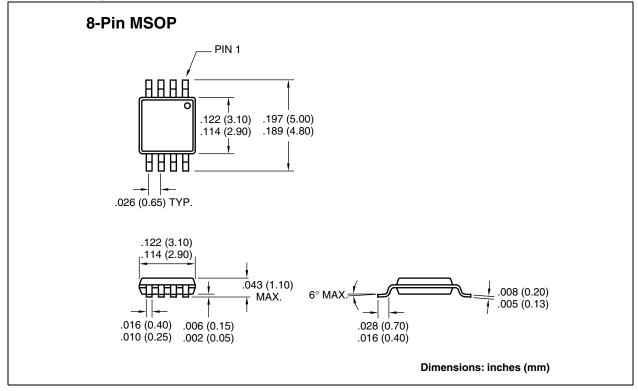
Package marking data not available at this time.

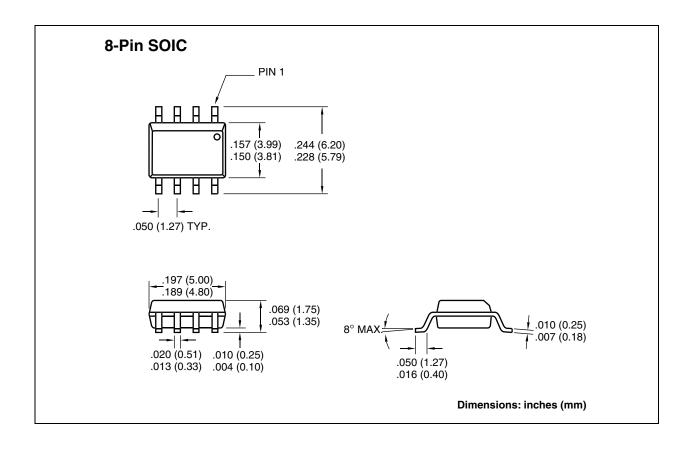
5.2 Taping Forms





5.3 Package Dimensions





NOTES:

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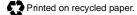
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